



Material Content Data Sheet



Sales Product Name		BAR 63-02L E6327		Issued		31. July 2018			
MA#		MA001789466							
Package		PG-TSLP-2-1		Weight*		0.52 mg			
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	non noble metal	tin	7440-31-5	0.001	0.10		1040		
	noble metal	gold	7440-57-5	0.002	0.40		4037		
	inorganic material	silicon	7440-21-3	0.026	4.93	5.43	49275	54352	
leadframe	non noble metal	nickel	7440-02-0	0.100	19.31	19.31	193135	193135	
wire	noble metal	gold	7440-57-5	0.006	1.12	1.12	11166	11166	
encapsulation	inorganic material	antimonytrioxide	1309-64-4	0.000	0.03		349		
	organic material	carbon black	1333-86-4	0.004	0.70		6985		
	plastics	epoxy resin	-	0.049	9.43		94284		
	inorganic material	silicondioxide	60676-86-0	0.310	59.68	69.84	596781	698399	
leadfinish	noble metal	gold	7440-57-5	0.010	1.86	1.86	18584	18584	
plating	noble metal	palladium	7440-05-3	0.003	0.58		5780		
	noble metal	gold	7440-57-5	0.010	1.86	2.44	18584	24364	
*deviation	< 10%				Sum in total:		100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com